

COMPLIANT

N-Channel 40-V (D-S), 175 °C MOSFET

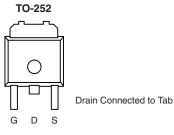
PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω)	$\mathbf{R}_{DS(on)}$ (Ω) \mathbf{I}_{D} (A) ^{a, c} Q		
40	0.016 at V _{GS} = 10 V	20	15.6 nC	
	0.018 at V _{GS} = 4.5 V	20	13.0110	

FEATURES

- TrenchFET[®] Power MOSFET
- 100 % Rg and UIS Tested

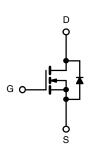
APPLICATIONS

- LCD TV Inverter
- Secondary Synchronous Rectification



Ordering Information: SUD50N04-16P-E3 (Lead (Pb)-free)

Top View



N-Channel MOSFET

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 16		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C T _C = 100 °C		20 ^c 20 ^c	_	
	$T_A = 25 \text{ °C}$	I _D	9.8 ^b		
	T _A = 100 °C		6.8 ^b	Α	
Pulsed Drain Current		IDM	50		
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	20 ^c		
	T _A = 25 °C	.5	2.5 ^b		
Single Pulse Avalanche Current		I _{AS}	20		
Avalanche Energy	L = 0.1 mH	E _{AS}	20	mJ	
	T _C = 25 °C		35.7		
Maximum Power Dissipation	T _C = 100 °C	P _D	17.8	w	
	T _A = 25 °C	· U	3.1 ^b		
	T _A = 100 °C		1.5 ^b		
Operating Junction and Storage Temperature Ra	T _J , T _{stq}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	3.4	5.3		

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface Mounted on 1" x 1" FR4 board.

c. Package limited.

SUD50N04-16P

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-					1	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			38		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.4			
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.8		2.2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 16 V$			± 100	nA	
	I _{DSS}	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	. цА	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$			20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
Ducin Courses On Otata Desistanced		V _{GS} = 10 V, I _D = 15 A		0.0125	0.016		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.014	0.018	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		58		S	
Dynamic ^b		·					
Input Capacitance	C _{iss}			1655		pF	
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		200			
Reverse Transfer Capacitance	C _{rss}			152			
Total Gate Charge	0	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 30 \text{ A}$		39.2	60	nC	
	Qg			15.6	24		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		4.2			
Gate-Drain Charge	Q _{gd}			5.5			
Gate Resistance	R _g	f = 1 MHz		2.1	3.2	Ω	
Turn-On Delay Time	t _{d(on)}			19	30	-	
Rise Time	t _r	V_{DD} = 20 V, R_{L} = 0.66 Ω		120	180		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 30$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$		40	60		
Fall Time	t _f			36	55	n 0	
Turn-On Delay Time	t _{d(on)}			8	16	ns	
Rise Time	t _r	V_{DD} = 20 V, R_{L} = 0.66 Ω		22	35	-	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D} \cong$ 30 A, V_GEN = 10 V, R_g = 1 Ω		24	36		
Fall Time	t _f			8	16		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			20	A	
Pulse Diode Forward Current ^a	I _{SM}				50		
Body Diode Voltage	V _{SD}	I _S = 10 A		0.84	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			25	38	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			22	33	nC	
Reverse Recovery Fall Time	t _a	$I_F = 20 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		15			
Reverse Recovery Rise Time	t _b	1 1		10		ns	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



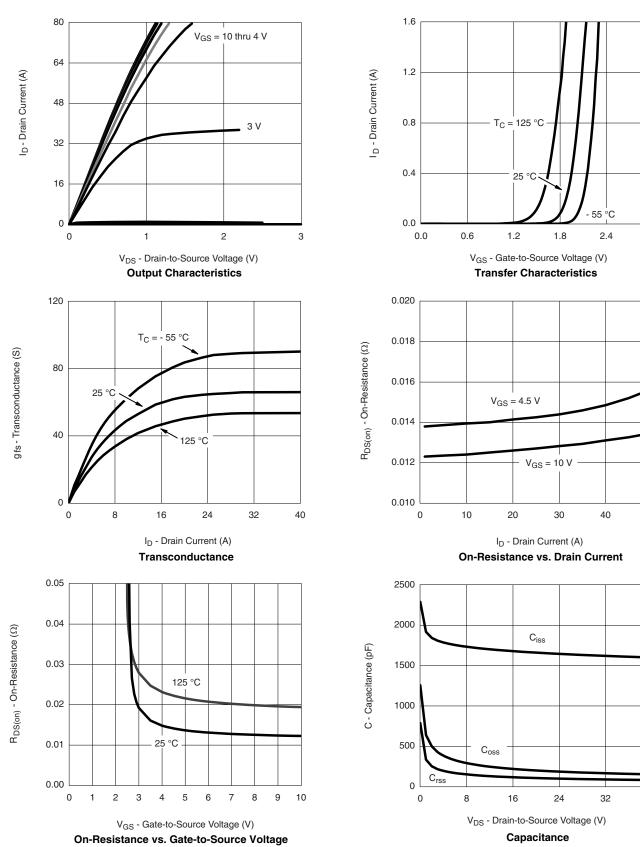
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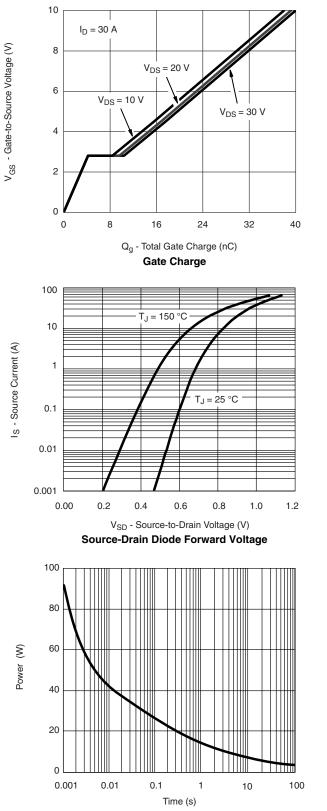




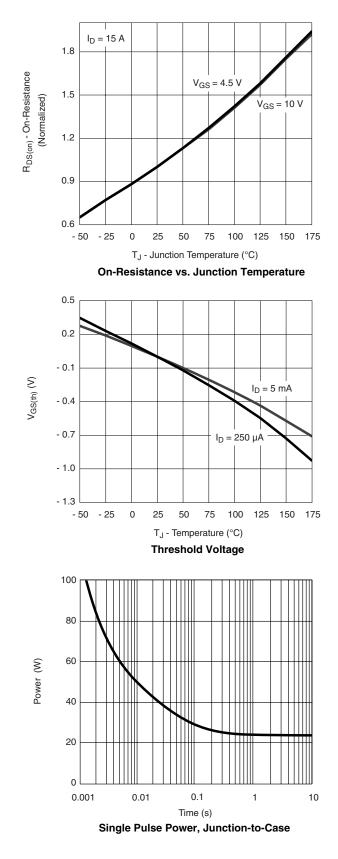
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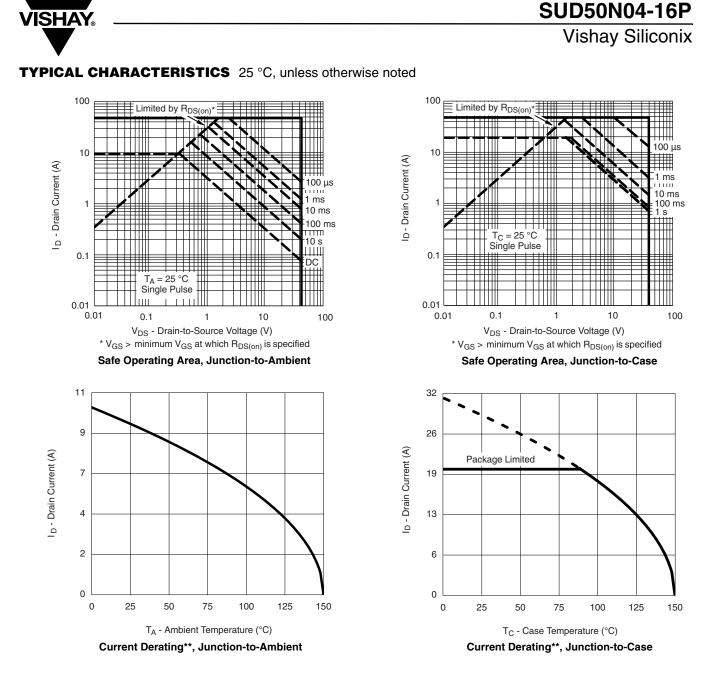
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



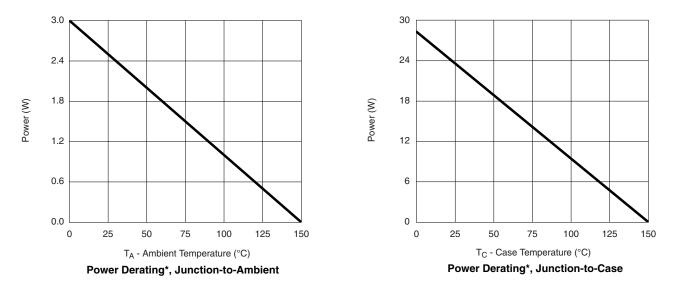
Single Pulse Power, Junction-to-Ambient





** The power dissipation P_D is based on $T_{J(max)} = 175$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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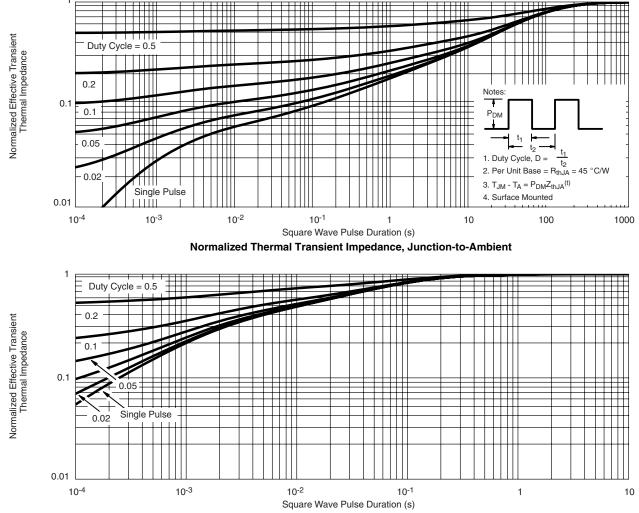


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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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